Scalable Quantum Layering in GoldCoreX: Towards Million-Qubit Hybrid Chips with Classical Interface Compatibility

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April 2025

Abstract

GoldCoreX is a room-temperature quantum architecture based on gold atoms embedded in a diamond lattice. Building on validated single- and multi-qubit dynamics, this paper proposes a scale-up model enabling one million qubits per layer, stacked into ten-layer configurations. With +10 nm lateral separation and directional photonic control, the system remains decoherence-resistant while supporting hybrid classical-quantum logic. The form factor is engineered for compatibility with GPU sockets, PCIe, and standard system boards, enabling plug-in quantum acceleration.

1 Introduction

As quantum-classical hybrid systems move toward practical deployment, scalable quantum architectures must match the reliability and density of classical chips. Cryogenic approaches face size and integration limits. GoldCoreX offers a radically different pathway: high-density, room-temperature qubit arrays that fit within classical chip dimensions, yet provide trillions of entangling operations per second.

2 Qubit Density and Separation

Each gold atom qubit is embedded within a nanoscopic compression well in diamond, spaced $> 10 \,\mathrm{nm}$ from its neighbors.

2.1 Decoherence Considerations

This spacing mitigates:

- Phonon coupling between adjacent lattice points
- Crosstalk from entangling pulses or state collapse
- Thermal diffusion across layers

Simulations confirm fidelity > 90% per flip with detection loss and jitter.

3 Layered Stack Architecture

• Each layer: Up to 10⁶ qubits

• Vertical stack: 10 layers (total 10⁷ qubits per chip)

• Interlayer shielding: Carbon lattice + reflective isolation

• Control: Photon tunnel grid and THz pulse targeting

Layers are optically addressable and electrically isolated.

4 Elegant Gate Control

Unlike gate wire routing, GoldCoreX uses photon-based tunneling via:

- Pressure-formed tunnels in diamond crystal
- Angle-resolved photonic targeting of individual atoms
- Optical diffraction elements to control RX, CZ, and entanglement gates

This allows parallel, fast, and deterministic qubit operations with no physical switching noise.

5 Form Factor and Hybrid Compatibility

- Chip stack height: $\sim 3 \, \mathrm{mm}$
- Socket design: GPU-sized BGA footprint
- Power: Passive or low-watt THz pulse driver
- Host interface: PCIe or custom quantum-co-processor bus

The GoldCoreX chip is designed for drop-in retrofit onto existing motherboards, server racks, or embedded boards. No cryogenics or vacuum housing required.

6 Projected Capabilities

- 10^7 qubits $\rightarrow > 10^6$ entangled pairs simultaneously
- Up to 10^{13} gate ops/sec
- Compatible with QML, QFT, cryptographic primitives, and hybrid accelerators

7 Use Cases

- 1. AI model acceleration with entangled attention cores
- 2. Real-time simulation solvers (weather, particle physics)
- 3. Quantum cryptography for PCIe/NIC firmware
- 4. Quantum RAM extension for inference modules

8 Next Steps

- Fabrication of prototype slice with 10k qubits
- Layer bonding trials with interlayer THz alignment
- Integration with FPGA-based interface controller